



US00D936017S

(12) **United States Design Patent**
Lu et al.

(10) **Patent No.:** **US D936,017 S**

(45) **Date of Patent:** **** Nov. 16, 2021**

(54) **FLOATING SOCKET CONNECTOR**

5,769,652 A 6/1998 Wider
6,488,136 B2 12/2002 Chang
6,715,382 B1* 4/2004 Hsien B25B 13/463
81/60

(71) Applicant: **Molex, LLC**, Lisle, IL (US)

(Continued)

(72) Inventors: **Chiu-Ming Lu**, Lisle, IL (US); **Ronald C. Hodge**, Lisle, IL (US); **Pierre Perez**, Aurora, IL (US)

FOREIGN PATENT DOCUMENTS

(73) Assignee: **Molex, LLC**, Lisle, IL (US)

CN 101752728 A 6/2010
CN 202977789 U 6/2010

(Continued)

(**) Term: **15 Years**

(21) Appl. No.: **29/753,451**

OTHER PUBLICATIONS

(22) Filed: **Sep. 30, 2020**

Molex 6.0mm Coeur CST High Current Connector System and Application Tools, dated Oct. 15, 2018, [online], [site visited Jul. 6, 2021]. Available from Internet, URL: https://www.molex.com/pdm_docs/as/2043130006-AS-000.pdf (Year: 2018).*

(Continued)

Related U.S. Application Data

(63) Continuation of application No. 16/330,767, filed on Mar. 6, 2019, now Pat. No. 10,892,576.

Primary Examiner — Shawn T Gingrich

(51) **LOC (13) Cl.** **13-03**

(74) *Attorney, Agent, or Firm* — Banner & Witcoff, Ltd.

(52) **U.S. Cl.**
USPC **D13/133; D13/146**

(58) **Field of Classification Search**
USPC D13/110, 112, 118, 123, 133, 146-149, D13/154, 173, 184, 199; D9/434, 435, D9/453, 772, 779, 780; D3/203.2
CPC H01R 12/91; H01R 13/00; H01R 13/18; H01R 13/187; H01R 13/13/627; H01R 13/631; H01R 25/16; H01R 25/162; H01R 12/71; H01R 13/24; H01R 13/502; H01R 13/62

See application file for complete search history.

(57) **CLAIM**

The ornamental design for a floating socket connector, as shown and described.

DESCRIPTION

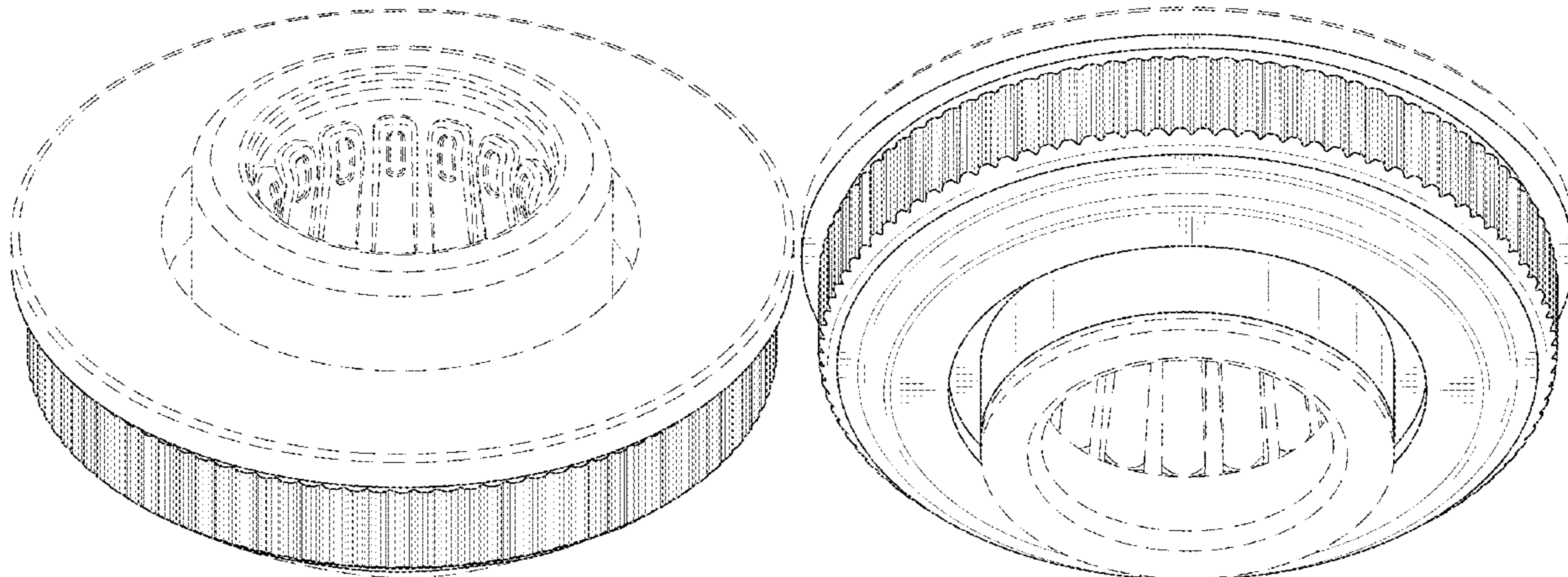
FIG. 1 is a top perspective view of a floating socket connector showing our new design;
FIG. 2 is a bottom perspective view thereof;
FIG. 3 is a front view thereof;
FIG. 4 is a rear view thereof;
FIG. 5 is a right side view thereof;
FIG. 6 is a left side view thereof;
FIG. 7 is a top view thereof; and,
FIG. 8 is a bottom view thereof.
The broken lines depicting the remainder of the floating socket connector form no part of the claimed design.

(56) **References Cited**

U.S. PATENT DOCUMENTS

D287,456 S 12/1986 Kobos
D332,557 S 1/1993 Blake et al.
D359,685 S * 6/1995 Luch D9/438
5,516,303 A 5/1996 Yohn et al.
D391,757 S * 3/1998 Johnson D3/203.2
5,769,552 A 6/1998 Kelley et al.

1 Claim, 8 Drawing Sheets



(56)

References Cited

U.S. PATENT DOCUMENTS

D491,428 S 6/2004 Barnett et al.
 D498,775 S 11/2004 Hu
 D498,776 S 11/2004 Hu
 D498,777 S 11/2004 Hu
 D498,778 S 11/2004 Hu
 D534,802 S * 1/2007 German D9/453
 D550,049 S 9/2007 Peng
 D550,050 S 9/2007 Peng
 D551,924 S 10/2007 Tuan Mu
 D558,006 S 12/2007 Tuan Mu
 D582,275 S * 12/2008 Reed D9/453
 D633,762 S 3/2011 Zhou et al.
 D636,265 S * 4/2011 Gartner D9/453
 D685,505 S * 7/2013 Yamamoto D26/2
 D723,370 S * 3/2015 Medlin D9/453
 D739,695 S 9/2015 Chang
 D743,223 S 11/2015 Chang
 D749,384 S 2/2016 Chang
 9,484,650 B2 11/2016 Shinder-Lerner et al.
 D867,298 S * 11/2019 Joniak D13/146
 D868,000 S * 11/2019 Joniak D13/146
 D869,000 S * 12/2019 Sonneman D26/113
 D877,702 S * 3/2020 Joniak D13/146
 D885,904 S * 6/2020 Kim D9/453
 D922,199 S * 6/2021 Kim D9/453
 2001/0054531 A1 * 12/2001 Chang B25B 13/463
 192/46
 2010/0099290 A1 4/2010 Gastineau
 2010/0124835 A1 5/2010 Johnson
 2010/0186228 A1 7/2010 Montena
 2010/0261361 A1 10/2010 Kasparian et al.
 2013/0109228 A1 5/2013 Sykes et al.
 2013/0161069 A1 * 6/2013 Erdle H01R 4/30
 174/135
 2014/0029900 A1 1/2014 Logan, Jr. et al.
 2014/0227900 A1 * 8/2014 Zitsch H01R 13/62
 439/359

2016/0141784 A1 5/2016 Hashiguchi
 2016/0332783 A1 * 11/2016 Kim B65D 41/3428
 2017/0338606 A1 * 11/2017 Copper H01R 43/20
 2018/0208333 A1 * 7/2018 Cesari H01R 13/04
 2019/0267735 A1 * 8/2019 Lu H01R 13/187
 2020/0358234 A1 * 11/2020 Liu H01R 13/5205

FOREIGN PATENT DOCUMENTS

CN 203574201 U 4/2014
 CN 104022376 A 9/2014
 CN 104332736 A 2/2015
 CN 204216296 U 3/2015
 JP S51-103267 A 9/1976
 JP H03-118572 U 12/1991
 JP H08-31488 A 2/1996
 JP 2000-182696 A 6/2000
 JP 2011-204607 A 10/2011
 JP 2016-096022 A 5/2016
 KR 2014-0112506 A 9/2014
 WO 2015/080946 A1 6/2015
 WO 2018/093981 A1 5/2018

OTHER PUBLICATIONS

High-current interconnect system eases PCB connections, dated Oct. 6, 2018, [online], [site visited Jul. 6, 2021]. Available from Internet, URL: <https://www.electronicproducts.com/high-current-interconnect-system-eases-pcb-connections/#> (Year: 2018).
 International Search Report and Written Opinion received for PCT application No. PCT/US2017/061910, dated Mar. 15, 2018, 9 pages.
 International Preliminary Report on Patentability received for PCT Application No. PCT/US2017/061910, dated May 31, 2019, 8 pages.
 Notification of Reasons for refusal received for JP application No. 2019-515860, dated Mar. 24, 2020, 15 pages. (8 pages of English translation and 7 pages of official copy).

* cited by examiner

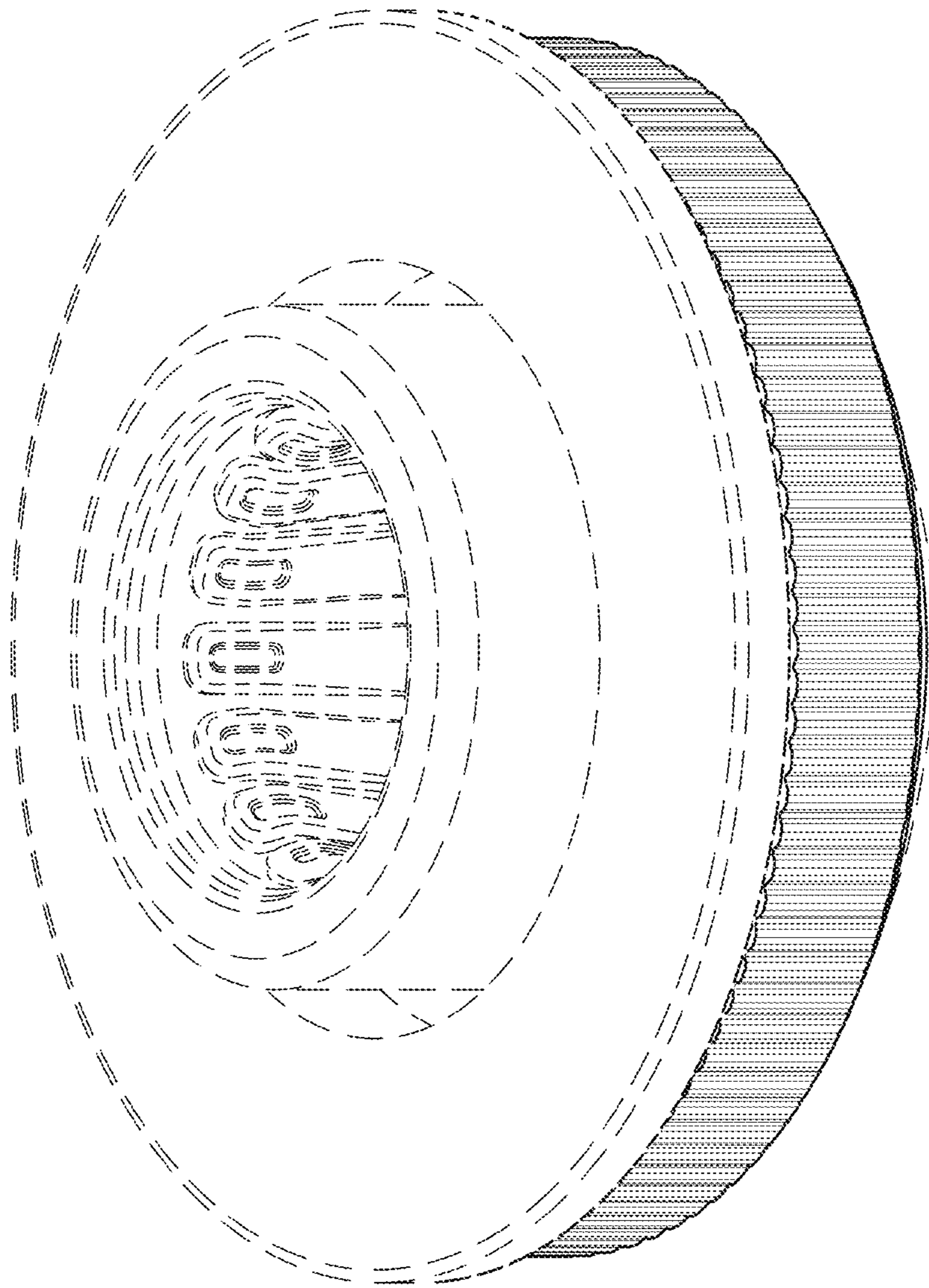


FIG. 1

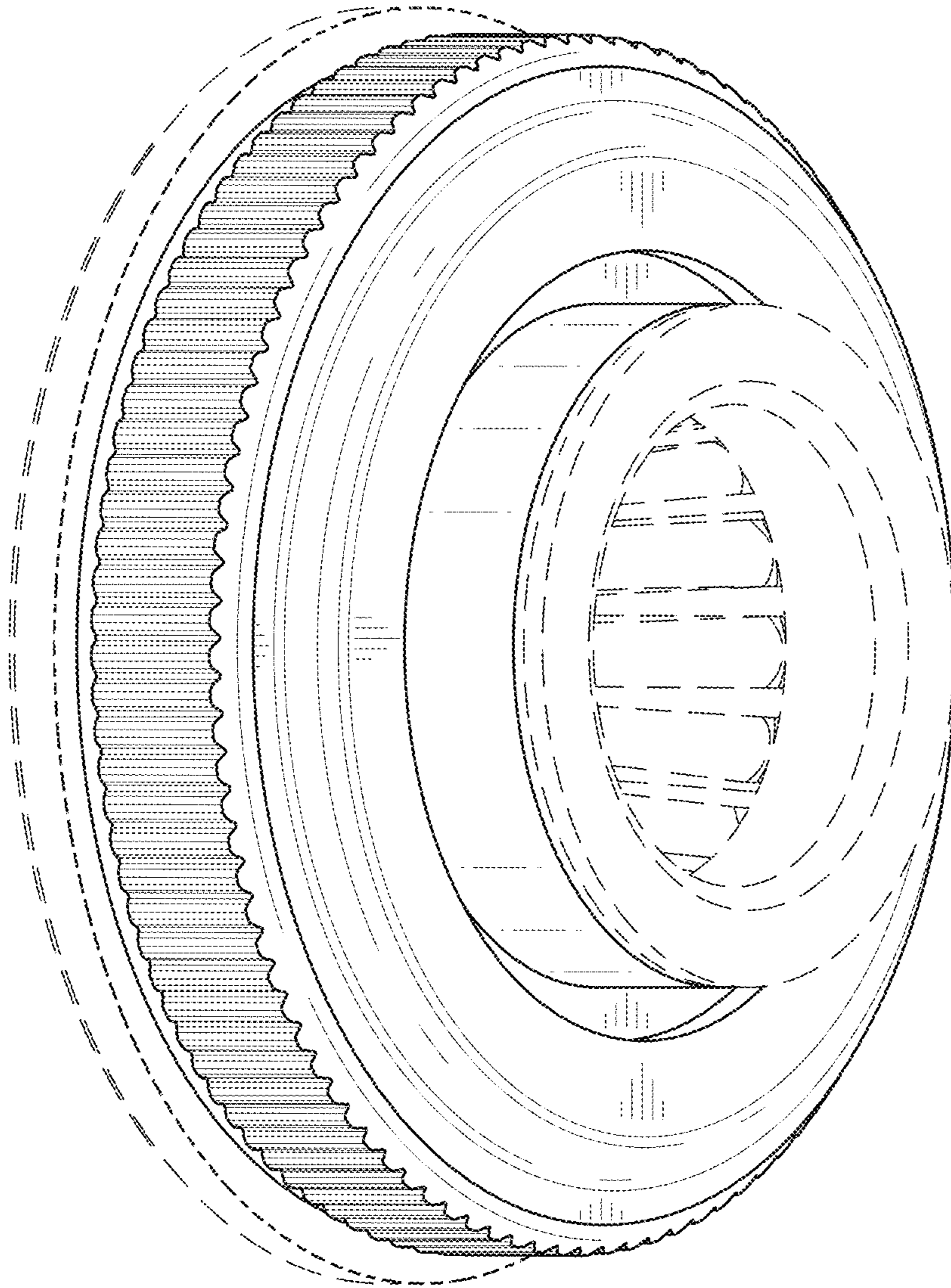


FIG. 2

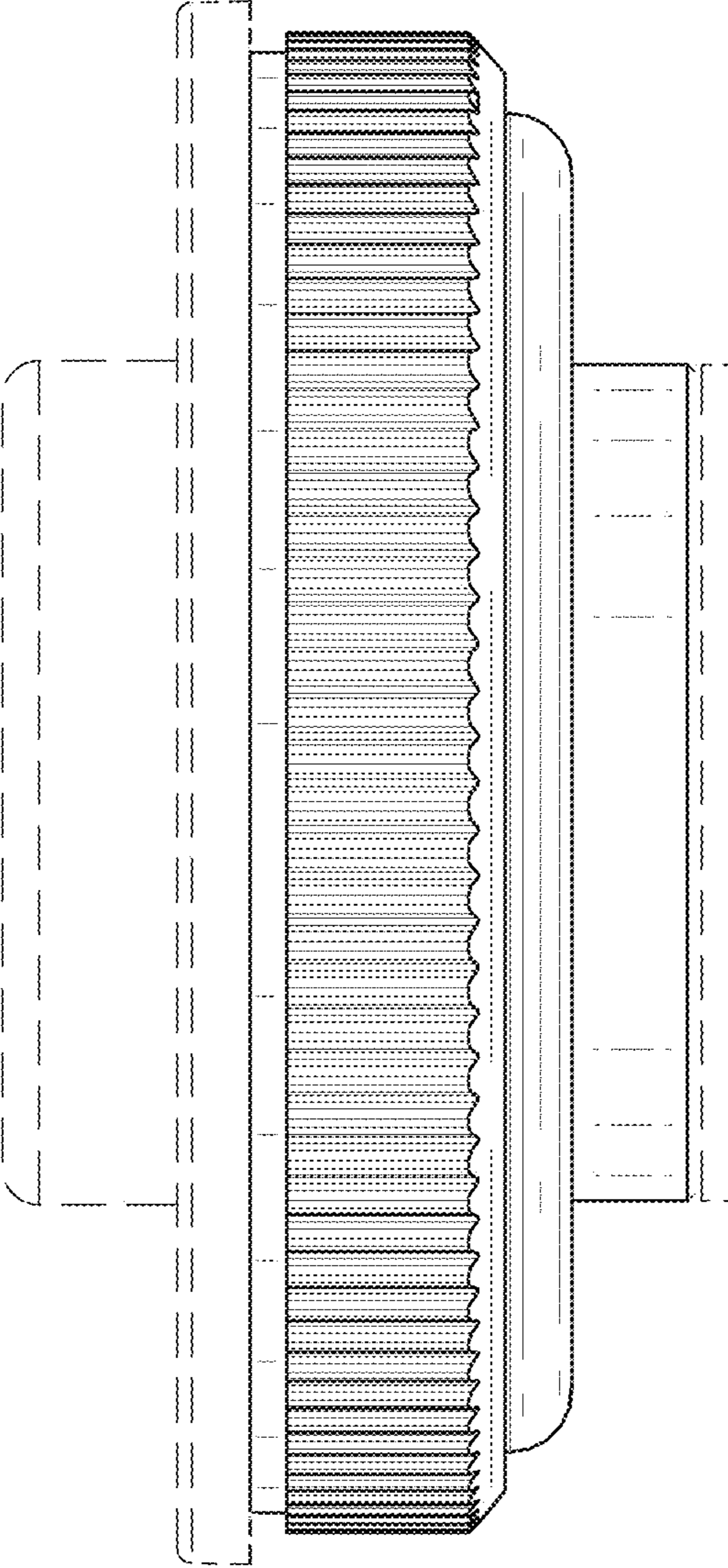


FIG. 3

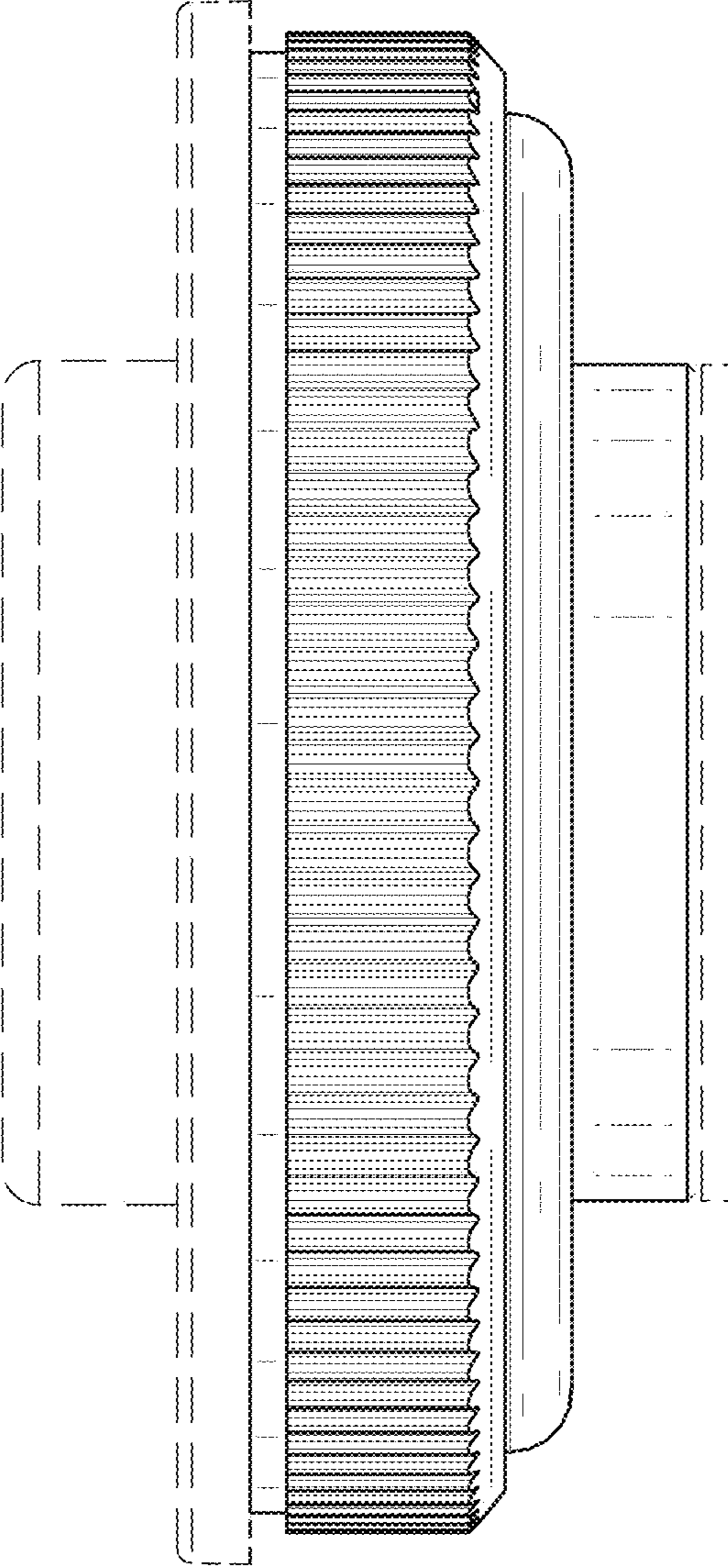


FIG. 4

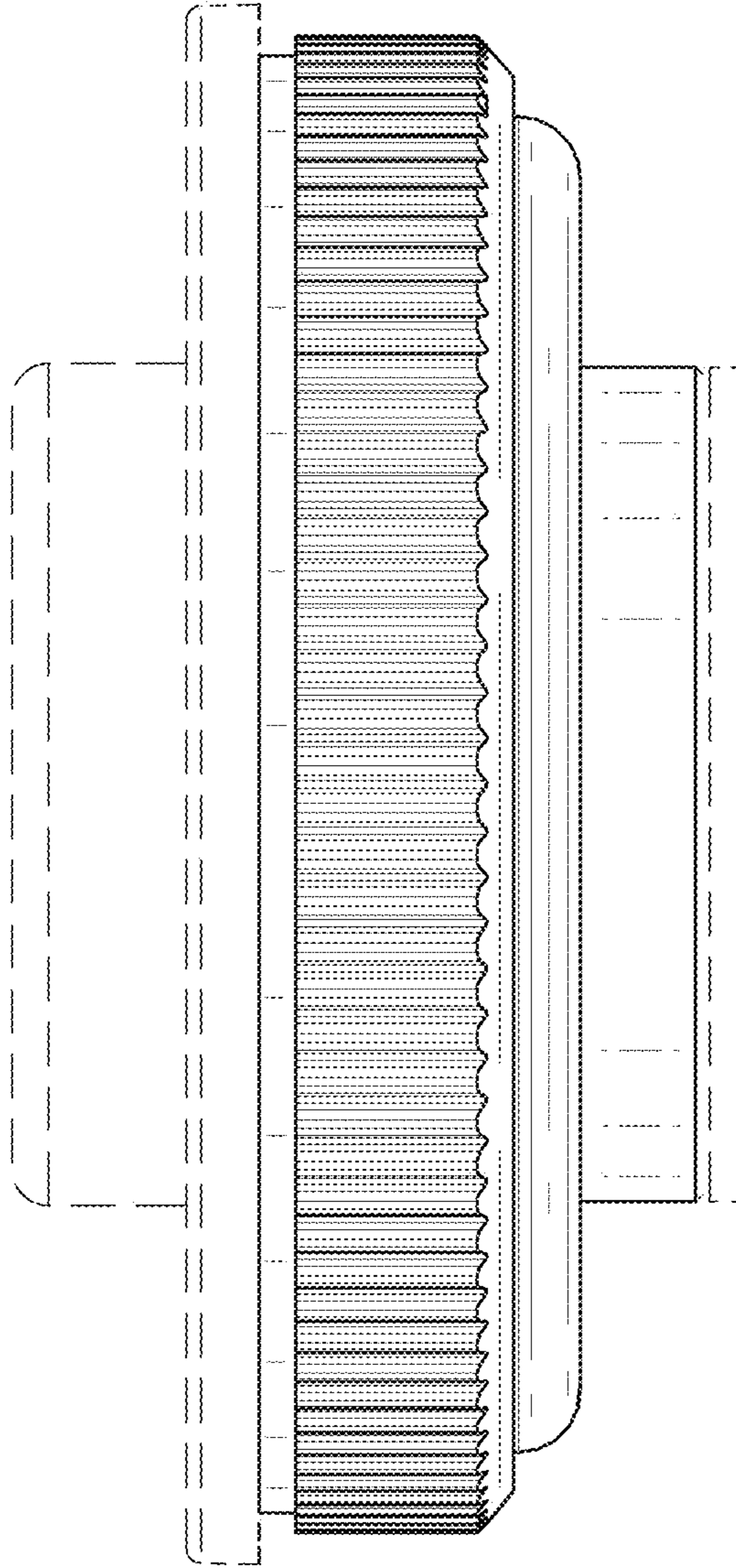


FIG. 5

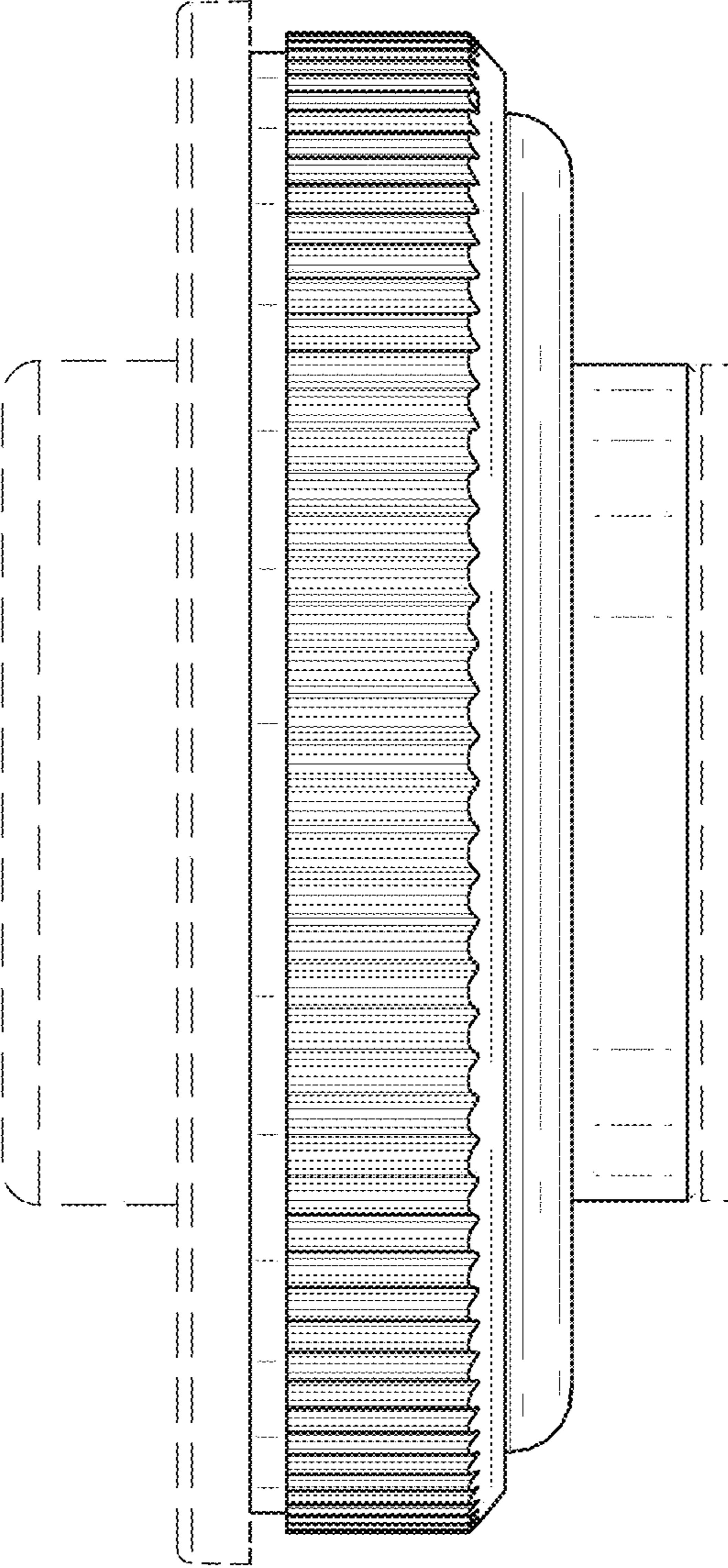


FIG. 6

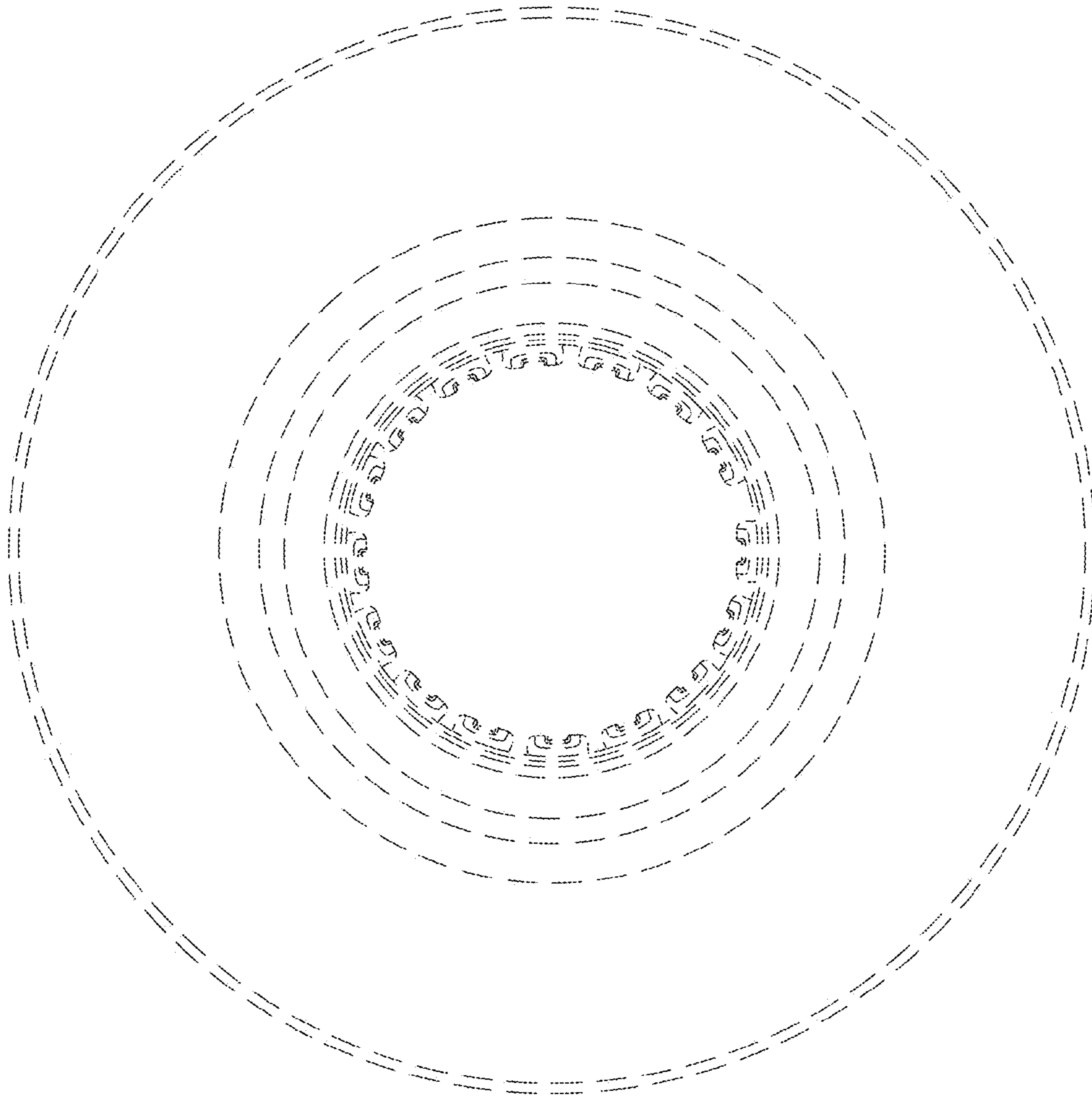


FIG. 7

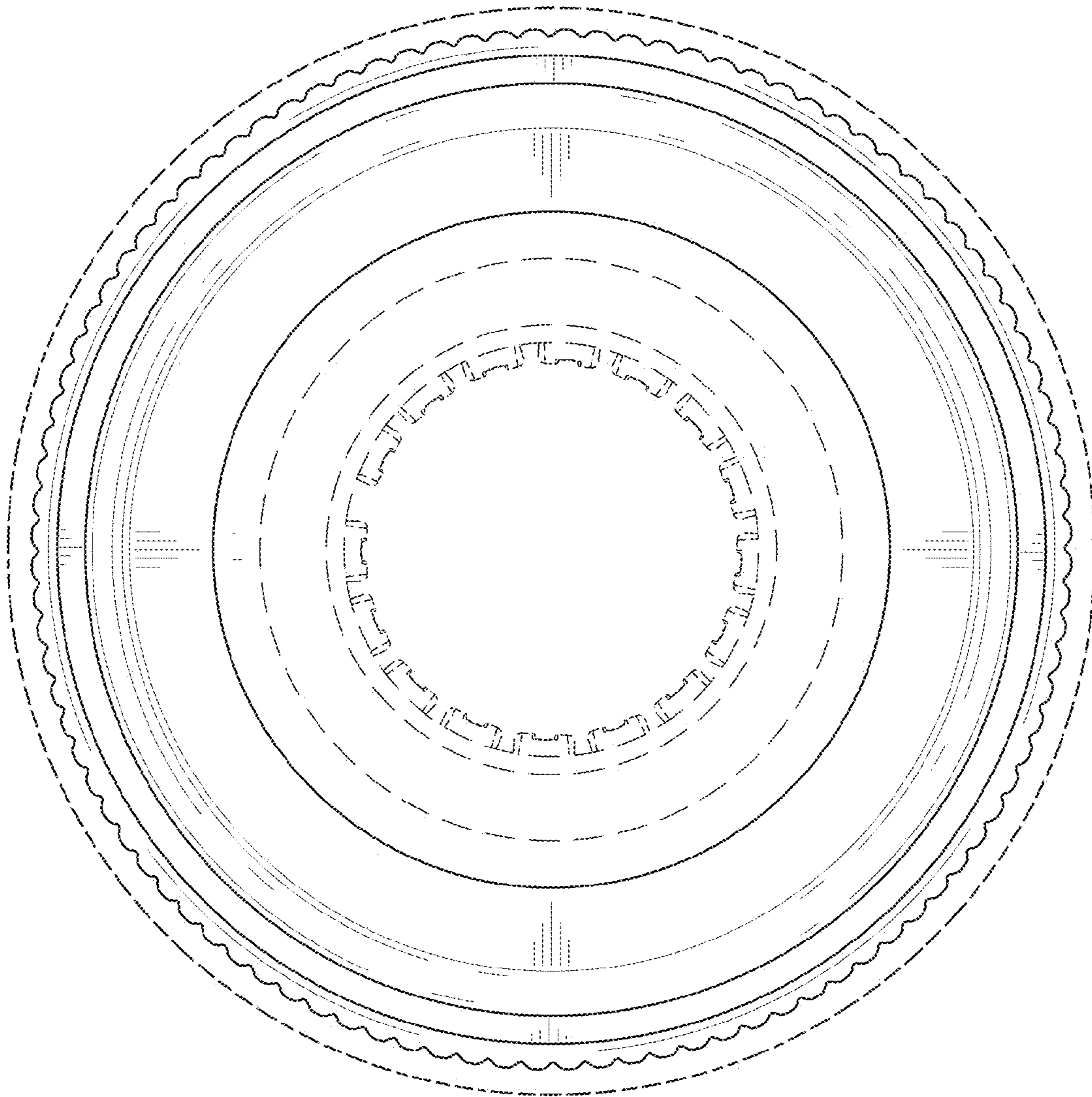


FIG. 8